**Product data sheet** 

## 1. General description

The ESDUDS05BF is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and low capacitance. The ESDUDS05BF is suited for using in cellular phones, portable device, digital cameras, power supplies and many other portable applications.

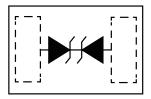
## 2. Features and benefits

- DFN1006 package
- Bidirectional ESD protection of one line
- Extremely low diode capacitance
- Extremely low clamping voltage to protect sensitive I/Os
- Extremely low inductance protection path to ground
- IEC 61000-4-2 (ESD) ±20kV(air), ±12kV(contact)
- Halogen free and RoHS compliant

# 3. Applications

- Cell Phone Handsets and Accessories
- · Personal Digital Assistants
- Notebooks / Desktops / Servers
- Digital Visual Interfaces (DVI)
- Display Ports (DP)
- HDMI1.3/1.4/2.0
- USB2.0/3.0/3.1









# 4. Absolute maximum ratings

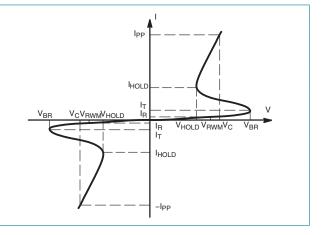
In accordance with the Absolute Maximum Rating System (IEC 60134).  $T_i = 25$  °C unless otherwise specified.

| Symbol                  | Parameter  | Conditions               | Values     | Unit     |  |  |
|-------------------------|--|--------------------------|------------|----------|--|--|
| Absolute maximum rating |  |                          |            |          |  |  |
| I <sub>PP</sub>         | peak pulse current   | t <sub>p</sub> = 8/20 μs | 5          | Α        |  |  |
| V <sub>ESD</sub>        | ESD per IEC 61000-4-2 (air)<br>ESD per IEC 61000-4-2 (contact) |                          | ±20<br>±12 | kV<br>kV |  |  |
| T <sub>stg</sub>        | storage temperature range                                      |                          | -55 to 150 | °C       |  |  |
| T <sub>j</sub>          | operating temperature range                                    |                          | -55 to 150 | °C       |  |  |

## 5. Characteristics

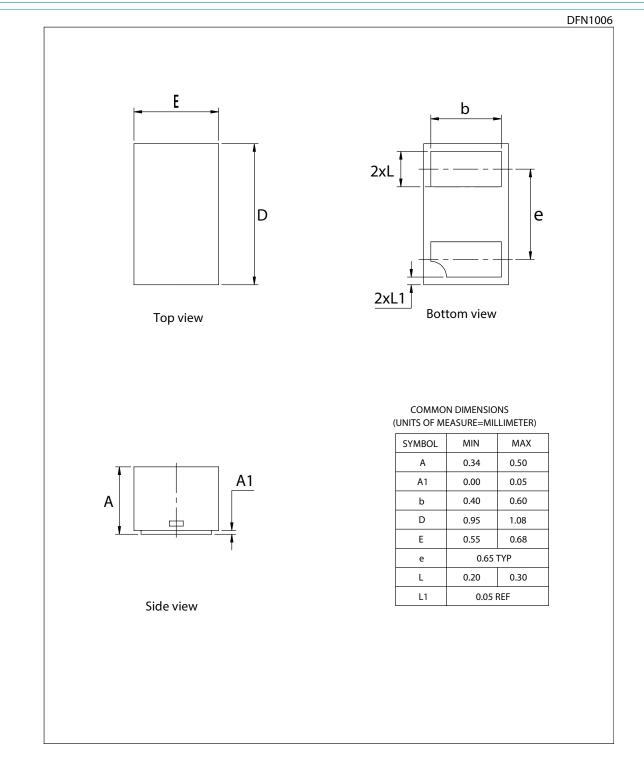
 $T_j$  = 25 °C unless otherwise specified.

| Symbol          | Parameter                 |  |
|-----------------|---------------------------|--|
| $V_{RWM}$       | Reverse Working Voltage   |  |
| $V_{BR}$        | Reverse Breakdown Voltage |  |
| I <sub>R</sub>  | Reverse Leakage Current   |  |
| I <sub>T</sub>  | Tect current              |  |
| V <sub>H</sub>  | Holding Reverse Voltage   |  |
| I <sub>PP</sub> | Peak Pulse Current        |  |
| V <sub>C</sub>  | Clamping Voltage          |  |
|                 |                           |  |
|                 |                           |  |



| Symbol         | Parameter                 | Condition                                       | Min | Тур | Max | Unit |
|----------------|---------------------------|---|-----|-----|-----|------|
| $V_{RWM}$      | Reverse Working Voltage   |   | -   | -   | 5   | V    |
| $V_{BR}$       | Reverse Breakdown Voltage | I <sub>τ</sub> = 1 mA                           | 5.6 | -   | -   | V    |
| I <sub>R</sub> | Reverse Leakage Current   | V <sub>RWM</sub> = 5 V                          | -   | -   | 1   | μA   |
| V <sub>H</sub> | Holding Reverse Voltage   |   | 2   | -   | -   | V    |
| V <sub>C</sub> | Clamping Voltage          | $I_{PP} = 5 \text{ A}; t_p = 8/20  \mu\text{s}$ | -   | -   | 10  | V    |
| C <sub>J</sub> | Junction Capacitance      | V <sub>R</sub> = 0 V; f = 1 MHz                 | -   | -   | 0.4 | pF   |

# 6. Package outline



## **ESD Protection Diodes**

## 7. Legal information

#### **Data sheet status**

| Document status [1][2]               | Product status [3] | Definition  |
|--------------------------------------|--------------------|---|
| Objective<br>[short] data<br>sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary<br>[short] data<br>sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product<br>[short] data<br>sheet     | Production         | This document contains the product specification.                                     |

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**ESD Protection Diodes** 

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